

# TSPE DFW MID-CITIES CHAPTER

## 2026 Scholarship Application

**Application deadline is June 26, 2026**  
**Notification of award will be by July 31, 2026**

The DFW Mid-Cities Chapter of the Texas Society of Professional Engineers (TSPE) will award scholarships to students studying to become engineers in an engineering program at an ABET-accredited (Accreditation Board for Engineering and Technology) college or university. Upon verification of enrollment\*, these scholarships will be presented to the college in the student's name.

The application consists of six (6) sections. Please complete each of the sections on the following pages.

**To be eligible for a TSPE Chapter Scholarship a student must:**

- ◊ Be a United States citizen or legal resident
- ◊ Be a high school senior with a 2.5 or higher GPA entering college in the fall of 2026 or current college undergraduate
- ◊ Be enrolled or accepted in an ABET (Accreditation Board for Engineering and Technology) accredited engineering program (Visit [www.abet.org](http://www.abet.org) and click on "Find ABET- accredited Programs" to obtain a listing)
- ◊ Provide a completed Scholarship Application with all required attachments delivered or postmarked by June 26, 2026

**Instructions for submitting an application:**

- ◊ Complete the Scholarship Application form (attached)
- ◊ Provide documentation of all eligibility requirements as listed above
- ◊ Secure and attach all required documentation for the application
- ◊ Submit the entire application (including all components – Incomplete packets will not be considered) no later than June 26, 2026 by one of the following methods:
  - Via email (PREFERRED): [tspe.mid.cities@gmail.com](mailto:tspe.mid.cities@gmail.com) (ATTN: Scholarship Committee in the subject line)
  - By mail: DFW Mid-Cities Chapter, P.O. Box 201474, Arlington, TX 76006 (Postmarked no later than June 26, 2026).

**Assemble the application in the following order:**

- ◊ Proof of Eligibility – see "To be eligible" section above
- ◊ Completed application form
- ◊ Essay
- ◊ Two recommendations from non-relatives (teachers/professors preferred)
- ◊ Official transcript(s) (a school counselor must verify current courses)
- ◊ SAT or ACT scores

**TSPE scholarships are awarded on the basis of academic record, achievement, leadership, and career goals:**

- ◊ Academic performance – 15 points max.
- ◊ Activities and work experience – 25 points max.
- ◊ Essay – 25 points max.
- ◊ Recommendations – 15 points max.
- ◊ Organization & Neatness of Application – 5 points max.
- ◊ Extraordinary accomplishments – 15 points max.

\* Confirmation of enrollment will be required prior to award. Enrollment Verification Form will be provided to award winners after selection. Form must be completed prior to receiving funding in fall 2026. Scholarship will be paid directly to the university, in the student's name, upon official notification by the school FOLLOWING THE SEMESTER'S CENSUS DATE that the student is enrolled in an ABET-accredited engineering program and is attending classes.

**SECTION 1 – PERSONAL INFORMATION**

Name: \_\_\_\_\_  
Last First Middle

Date of Birth: \_\_\_\_\_ Phone: (\_\_\_\_) \_\_\_\_\_  
Month Day Year

Permanent Postal Address: \_\_\_\_\_  
Street Apt.  
\_\_\_\_\_  
City State Zip Code

E-Mail Address: \_\_\_\_\_

Ethnicity: \_\_\_\_\_Hispanic or Latino \_\_\_\_\_American Indian or Alaskan Native \_\_\_\_\_Asian  
\_\_\_\_\_Black or African American \_\_\_\_\_Native Hawaiian or Other Pacific Islander \_\_\_\_\_White  
\_\_\_\_\_Prefer not to answer

Are you a legal citizen or resident of the United States of America? \_\_\_\_\_

**SECTION 2 – ACADEMIC INFORMATION**

High School: \_\_\_\_\_ Phone: (\_\_\_\_) \_\_\_\_\_

School Address: \_\_\_\_\_

Person responsible for scholarship information at your school: \_\_\_\_\_

Phone: (\_\_\_\_) \_\_\_\_\_ E-Mail Address: \_\_\_\_\_

Class Rank: \_\_\_\_\_of \_\_\_\_\_ Cumulative Grade Point Average: \_\_\_\_\_on a \_\_\_\_\_scale

SAT Score: \_\_\_\_\_(Attach copy of score)

ACT Score: \_\_\_\_\_(Attach copy of score)

Colleges or Universities Currently Attending or Applied to  
(in order of preference):

	Enrolled/Accepted (y/n)	Date Applied
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_____	_____	_____
Institution Name	City and State	Month/Year

_____	_____	_____
Institution Name	City and State	Month/Year

_____	_____	_____
Institution Name	City and State	Month/Year

Planned Engineering Major: \_\_\_\_\_

### SECTION 3 – ACTIVITIES AND ACCOMPLISHMENTS

#### **Activities**

List no more than six of your activities (in or outside of school) of which you are most proud. Why are you proud of these accomplishments? (If necessary, please attach additional sheet)

#### **Accomplishments/Honors/Awards**

List no more than six of your most significant accomplishments outside of school. Explain why you believe these accomplishments are significant. (If necessary, please attach additional sheet)

**SECTION 4 – WORK EXPERIENCE** (Attach an additional sheet if necessary):

List your work experience and include the following information: 1) Dates (start & end); 2) Employer/Supervisor/Phone; 3) Job Duties; 4) Hours Worked; 5) Paid or Volunteer; and 6) During the School Year and/or Summer Breaks.

**SECTION 5 – ESSAY** (Please attach additional sheets):

The essay should be handwritten or computer generated in a 10-point font, double spaced, and not more than 750 words. Put your name, birth date, and planned major field of engineering at the top of the essay. Develop and title your essay based on one of the following three questions:

1. What people and/or events in your life led you to choose to study engineering?
2. Describe accomplishments that illustrate your aptitude for and interest in engineering.
3. What aspects of engineering influenced your decision to select it as a profession?

Note: Essays often serve as tiebreakers between closely ranked applicants. A well thought out essay enhances your chances of winning a scholarship.

**SECTION 6 – CERTIFICATION** (Applications without required signatures will be disqualified.)

**Scholarship Applicant:**

To the best of my knowledge, the information presented on this application is complete and true. I understand my application will not be reviewed if it is incomplete. By signing below, I authorize my school officials to release information about my academic records to representatives of TSPE.

\_\_\_\_\_  
Applicant Signature

\_\_\_\_\_  
Date

**Parental/Legal Guardian Certification (If under 18 years old):**

I certify that all information presented on this application is complete and true.

\_\_\_\_\_  
Parent/Legal Guardian Signature

\_\_\_\_\_  
Date

\_\_\_\_\_  
Printed Name

( ) \_\_\_\_\_  
Parent/Legal Guardian Phone Number